

P-Channel 30-V (D-S) MOSFET

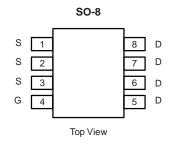
| PRODUCT SUMMARY | | | | | |
|---------------------|-----------------------------------|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^d | Q _g (Typ.) | | |
| - 30 | 0.018 at V _{GS} = - 10 V | - 9.0 | 13 nC | | |
| - 30 | 0.024 at V_{GS} = - 4.5 V | - 7.8 | 13110 | | |

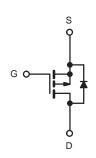
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % Rg Tested

APPLICATIONS

- Load Switch
- Battery Switch





P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS T | A = 25 °C, unless othe | erwise noted | | |
|--|-----------------------------------|--------------|-----------------------|----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | - 30 | V | |
| Gate-Source Voltage | V _{GS} | ± 20 | v | |
| | T _C = 25 °C | | - 9.0 | |
| Continuous Drain Current (T ₁ = 150 °C) | T _C = 70 °C | | - 7.2 | |
| Continuous Drain Current $(T_j = 150^{\circ} C)$ | T _A = 25 °C | | - 7.0 ^{a, b} | |
| | T _A = 70 °C | | - 5.6 ^{a, b} | А |
| Pulsed Drain Current | I _{DM} | - 30 | | |
| Continuous Course Drain Diada Current | T _C = 25 °C | | - 3.5 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | Is I | - 2.1 ^{a, b} | |
| | T _C = 25 °C | | 4.2 | |
| Maximum Davias Disaination | T _C = 70 °C | | 2.7 | w |
| Maximum Power Dissipation | T _A = 25 °C | FD FD | 2.5 ^{a, b} | vv |
| | T _A = 70 °C | 1 | 1.6 ^{a, b} | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|--------------|-------------------|---------|---------|-------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 40 | 50 | °C/W |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 24 | 30 | 0,000 |

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 95 °C/W.

d. Based on $T_C = 25 \ ^{\circ}C$.

Available

| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$ | SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted | | | | | | | | |
|---|--|-------------------------|--|-------|--------|-------|--------|--|--|
| $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | Static | | | | | | | | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | Drain-Source Breakdown Voltage | | V _{GS} = 0 V, I _D = - 250 µA | - 30 | | | V | | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I 250 uA | | - 31 | | m\//°C | | |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$ | V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | η - 200 μΑ | | 4.5 | | mv/°C | | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 1.0 | | - 2.5 | V | | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | Gate-Source Leakage | I _{GSS} | | | | ± 100 | nA | | |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$ | Zara Cata Valtaga Drain Current | | | | | - 1 | | | |
| $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | Zero Gale voltage Drain Current | DSS | V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C | | | - 5 | μΑ | | |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$ | On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le -5 V, V_{GS} = -10 V$ | - 20 | | | А | | |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$ | | _ | V _{GS} = - 10 V, I _D = - 7.0 A | | 0.018 | | Ω | | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | Drain-Source On-State Resistance" | NDS(on) | V _{GS} = - 4.5 V, I _D = - 5.6 A | | 0.024 | | | | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 7.0 A | | 18 | | S | | |
| $ \begin{array}{ c c c c c c } \hline \text{Output Capacitance} & C_{OSS} & V_{DS} = \cdot 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & 180 & \\ \hline & 145 & \\ \hline & 13 & 20 & \\ \hline & 15.5 & \\ \hline & 105 & 100 & 20 & \\ \hline & 105 & 15 \ V, \ V_{GS} = \cdot 4.5 \ V, \ V_{GS} = \cdot 4.5 \ V, \ V_{D} = \cdot 7.0 \ A & \\ \hline & 3.5 & \\ \hline & 105 & 100 & 20 & \\ \hline & 105 & 100 & 20 & \\ \hline & 105 & 100 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 38 & 57 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 38 & 57 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 38 & 57 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 38 & 57 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 105 & 100 \ V_{DD} = -15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 105 & 100 \ V_{DD} = -15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 105 & 100 \ V_{DD} = -15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 110 \ 11 & 17 & \\ \hline & 111 \ 17 & \\ \hline & 111 \$ | Dynamic ^b | | | | | | • | | |
| $ \begin{array}{ c c c c c c } \hline \text{Output Capacitance} & C_{OSS} & V_{DS} = \cdot 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & 180 & \\ \hline & 145 & \\ \hline & 13 & 20 & \\ \hline & 15.5 & \\ \hline & 105 & 100 & 20 & \\ \hline & 105 & 15 \ V, \ V_{GS} = \cdot 4.5 \ V, \ V_{GS} = \cdot 4.5 \ V, \ V_{D} = \cdot 7.0 \ A & \\ \hline & 3.5 & \\ \hline & 105 & 100 & 20 & \\ \hline & 105 & 100 & 20 & \\ \hline & 105 & 100 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 38 & 57 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 38 & 57 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 38 & 57 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 38 & 57 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 105 & 15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 105 & 100 \ V_{DD} = -15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 105 & 100 \ V_{DD} = -15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 105 & 100 \ V_{DD} = -15 \ V, \ R_L = 2.7 \ \Omega & 89 & 134 & \\ \hline & 110 \ 11 & 17 & \\ \hline & 111 \ 17 & \\ \hline & 111 \$ | Input Capacitance | C _{iss} | | | 1455 | | | | |
| $ \begin{array}{ c c c c c c } \hline Reverse Transfer Capacitance & C_{rss} & & & & & 145 & & & \\ \hline Total Gate Charge & Q_{g} & V_{DS} = -15 \ V, \ V_{GS} = -10 \ V, \ I_{D} = -7.0 \ A & & 25 & 38 & & \\ \hline Gate-Source Charge & Q_{gs} & V_{DS} = -15 \ V, \ V_{GS} = -4.5 \ V, \ I_{D} = -7.0 \ A & & 3.5 & & \\ \hline Gate-Drain Charge & Q_{gd} & & & & & & & \\ \hline Gate Resistance & R_{g} & f = 1 \ MHz & 0.4 & 2.0 & 4.0 & \Omega & \\ \hline Gate Resistance & R_{g} & f = 1 \ MHz & 0.4 & 2.0 & 4.0 & \Omega & \\ \hline Turn-On Delay Time & t_{d(on)} & & & & & \\ \hline Rise Time & t_{r} & V_{DD} = -15 \ V, \ R_{L} = 2.7 \ \Omega & 13 & 200 & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = -10 \ V, \ R_{g} = 1 \ \Omega & & & & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = -10 \ V, \ R_{g} = 1 \ \Omega & & & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = -4.5 \ V, \ R_{g} = 1 \ \Omega & & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = -4.5 \ V, \ R_{g} = 1 \ \Omega & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = -4.5 \ V, \ R_{g} = 1 \ \Omega & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ V_{GS} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ U_{S} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ U_{S} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ U_{S} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ U_{S} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ U_{S} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ U_{S} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ U_{S} = 0 \ V & \\ \hline I_{D} = -5.6 \ A, \ U_{S$ | Output Capacitance | C _{oss} | V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz | | 180 | | pF | | |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $ | Reverse Transfer Capacitance | | | | 145 | | | | |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$ | Tatal Cata Charge | | V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 7.0 A | | 25 | 38 | | | |
| $ \begin{array}{ c c c c c c c } \hline Gate-Source Charge & Q_{gs} & V_{DS} = -15 \ V, \ V_{GS} = -4.5 \ V, \ I_D = -7.0 \ A & 3.5 & \\ \hline & 5.5 & \\ \hline & 6.4 & \\ \hline & 6.4 & 2.0 & 4.0 & \\ \hline & 0.4 & 2.0 & 4.0 & \\ \hline & 0.1 & 20 & \\ \hline & 10 & 20 & \\ \hline & 113 & 20 & \\ \hline & 11 & 17 & \\ \hline & $ | Iotal Gate Charge | Qg | | | 13 | 20 | | | |
| $ \begin{array}{ c c c c c c } \hline Gate-Drain Charge & Q_{gd} & & & & & & & & & & & & & & & & & & &$ | Gate-Source Charge | Q _{gs} | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -7.0 \text{ A}$ | | 3.5 | | nC | | |
| $ \begin{array}{c c c c c c c c c c } \hline Gate Resistance & R_g & f = 1 \ MHz & 0.4 & 2.0 & 4.0 & \Omega \\ \hline Iurn-On Delay Time & t_{d(on)} & & & & & & & & & & & & & & & & & & &$ | Gate-Drain Charge | Q _{gd} | | | 5.5 | | | | |
| $\begin{array}{c c c c c c c c c } \hline Rise Time & t_r & V_{DD} = -15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega & 23 & 35 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega & 9 & 18 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega & 38 & 57 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GS} = 0 \ V & -0.71 \ -1.2 \ V \\ \hline I_D \cong 0 \ O O O O O O O O O O O O O O O O O O$ | Gate Resistance | | f = 1 MHz | 0.4 | 2.0 | 4.0 | Ω | | |
| $\begin{array}{c c c c c c c c c } \hline Rise Time & t_r & V_{DD} = -15 \ V, \ R_L = 2.7 \ \Omega & 13 & 20 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega & 23 & 35 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega & 9 & 18 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega & 38 & 57 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega & 11 & 17 \\ \hline I_D \cong -5.6 \ A, \ V_{GS} = 0 \ V & -0.71 \ -1.2 \ V \\ \hline I_D \cong 0 \ O O O O O O O O O O O O O O O O O O$ | Turn-On Delay Time | t _{d(on)} | | | 10 | 20 | | | |
| $\begin{tabular}{ c c c c c c c } \hline Fall Time & t_f & & & & & & & & & & & & & & & & & & &$ | Rise Time | | V_{DD} = - 15 V, R _L = 2.7 Ω | | 13 | 20 | | | |
| $\begin{tabular}{ c c c c c c } \hline Turn-On Delay Time & t_d(on) & t_r & & & & & & & & & & & & & & & & & & &$ | Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 5.6 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 23 | 35 | | | |
| $\begin{tabular}{ c c c c c c c } \hline Turn-On Delay Time & t_{d(on)} & & & & & & & & & & & & & & & & & & &$ | Fall Time | t _f | | | 9 | 18 | | | |
| $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | Turn-On Delay Time | t _{d(on)} | | | 38 | 57 | ns | | |
| Fall Time t_f 1117Drain-Source Body Diode CharacteristicsContinous Source-Drain Diode Current I_S $T_C = 25 \ ^{\circ}C$ -6.5 Pulse Diode Forward Current I_{SM} -30 -30 Body Diode Voltage V_{SD} $I_S = -5.6 \ A, \ V_{GS} = 0 \ V$ -0.71 -1.2 V Body Diode Reverse Recovery Time t_{rr} 222 333 nsBody Diode Reverse Recovery Charge Q_{rr} $I_F = -5.6 \ A, \ dl/dt = 100 \ A/\mus, \ T_J = 25 \ ^{\circ}C$ 11 17 26 nC | Rise Time | t _r | V_{DD} = - 15 V, R_L = 2.7 Ω | | 89 | 134 | | | |
| $\begin{tabular}{ c c c c c } \hline \textbf{Drain-Source Body Diode Characteristics} \\ \hline \textbf{Continous Source-Drain Diode Current} & I_S & T_C = 25 \ ^{\circ}\text{C} & -6.5 & \\ \hline \textbf{Pulse Diode Forward Current} & I_{SM} & -30 & \\ \hline \textbf{Body Diode Voltage} & V_{SD} & I_S = -5.6 \ \text{A}, \ V_{GS} = 0 \ \text{V} & -0.71 & -1.2 & \ \text{V} & \\ \hline \textbf{Body Diode Reverse Recovery Time} & t_{rr} & \\ \hline \textbf{Body Diode Reverse Recovery Charge} & Q_{rr} & \\ \hline \textbf{Reverse Recovery Fall Time} & t_a & \\ \hline \end{tabular}$ | Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 5.6 A, V_{GEN} = - 4.5 V, R_g = 1 Ω | | 22 | 33 | | | |
| $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | Fall Time | t _f | | | 11 | 17 | | | |
| Pulse Diode Forward CurrentI SMI SM- 30ABody Diode VoltageV SDI S = - 5.6 A, V GS = 0 V- 0.71- 1.2VBody Diode Reverse Recovery Time t_{rr} 2233nsBody Diode Reverse Recovery Charge Q_{rr} I F = - 5.6 A, dI/dt = 100 A/µs, T J = 25 °C1726nCReverse Recovery Fall Time t_a nsnsns | Drain-Source Body Diode Characteristics | | | | | | | | |
| Pulse Diode Forward CurrentI SMI S-30Body Diode VoltageV SDI SI S-0.71-1.2VBody Diode Reverse Recovery Time t_{rr} 2233nsBody Diode Reverse Recovery Charge Q_{rr} I FI F-5.6 A, dl/dt = 100 A/µs, T J = 25 °C1726nCReverse Recovery Fall Time t_a nsnsnsns | Continous Source-Drain Diode Current | ۱ _s | T _C = 25 °C | | | - 6.5 | ۸ | | |
| Body Diode Reverse Recovery Time t_{rr} 2233nsBody Diode Reverse Recovery Charge Q_{rr} $I_F = -5.6 \text{ A}, dI/dt = 100 \text{ A/µs}, T_J = 25 \text{ °C}$ 1726nCReverse Recovery Fall Time t_a 13 ns | Pulse Diode Forward Current | I _{SM} | | | | - 30 | A | | |
| Body Diode Reverse Recovery Charge Q_{rr} IIReverse Recovery Fall Time t_a II | Body Diode Voltage | | I _S = - 5.6 A, V _{GS} = 0 V | | - 0.71 | - 1.2 | V | | |
| Body Diode Reverse Recovery Charge Q_{rr} $I_F = -5.6 \text{ A}, dI/dt = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ 1726nCReverse Recovery Fall Time t_a $I_F = -5.6 \text{ A}, dI/dt = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ 13ns | Body Diode Reverse Recovery Time | - | | | 22 | 33 | ns | | |
| Reverse Recovery Fall Time t_a $I_F = -5.6 \text{ A, di/dt} = 100 \text{ A/ps}, I_J = 25 \text{ C}$ 13 ns | Body Diode Reverse Recovery Charge | | | | 17 | 26 | nC | | |
| | | | $1 I_F = -5.6 \text{ A}, \text{ al/at} = 100 \text{ A/}\mu\text{s}, I_J = 25 \text{ °C}$ | | 13 | | | | |
| | Reverse Recovery Rise Time | | 1 | | 9 | | - ns | | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

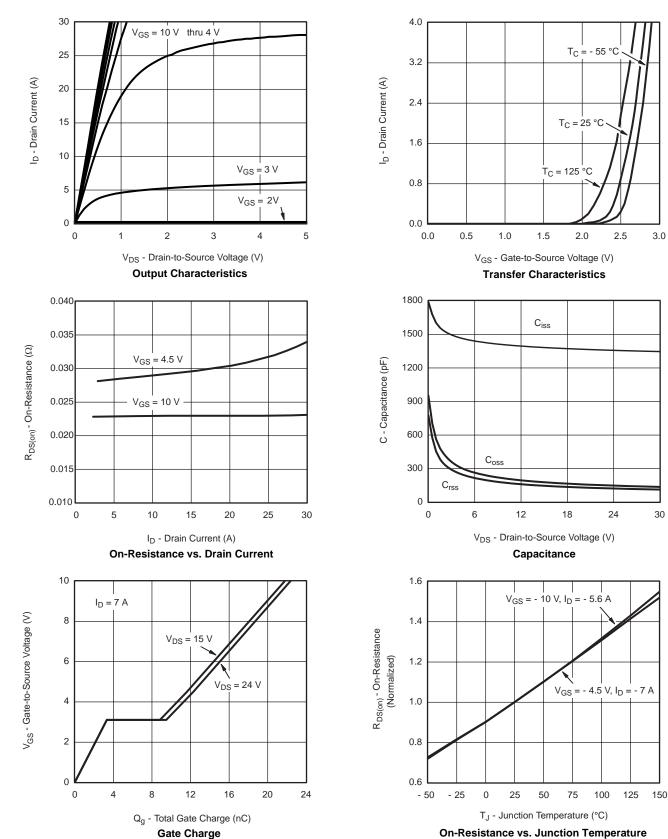
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

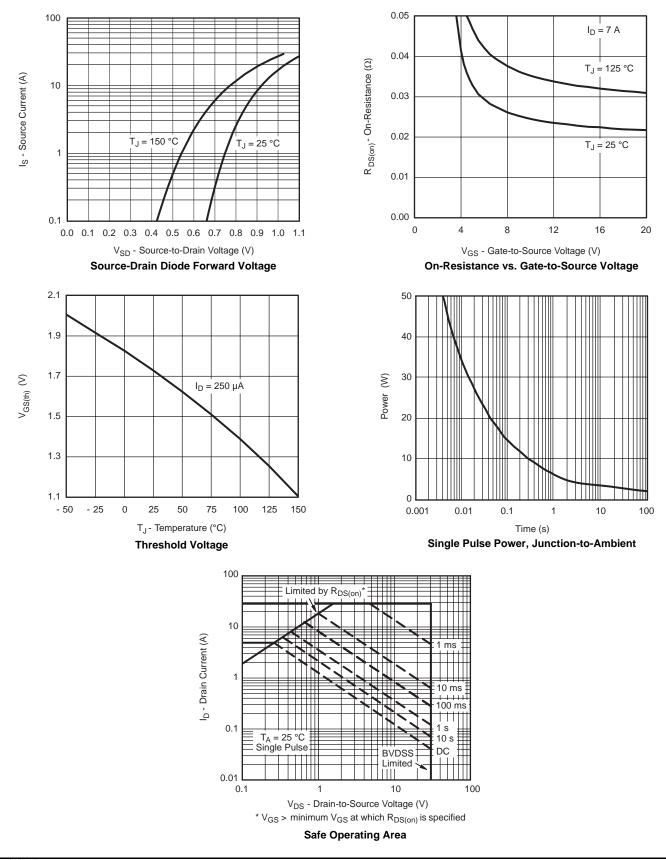
semi

www.VBsemi.com

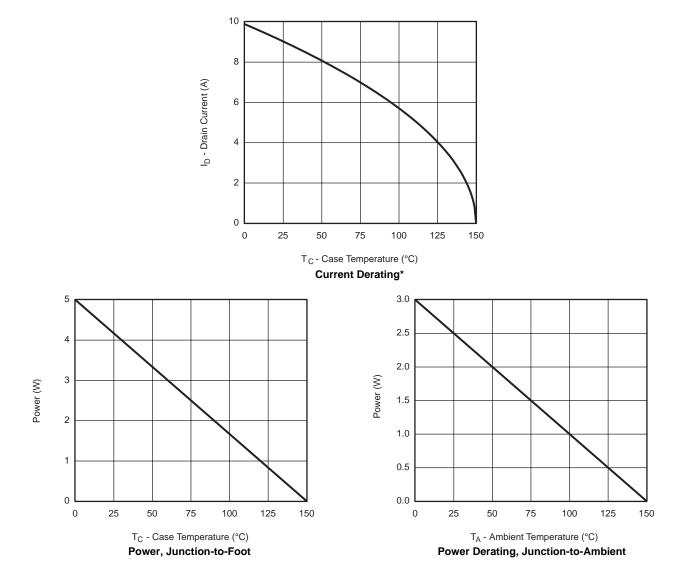






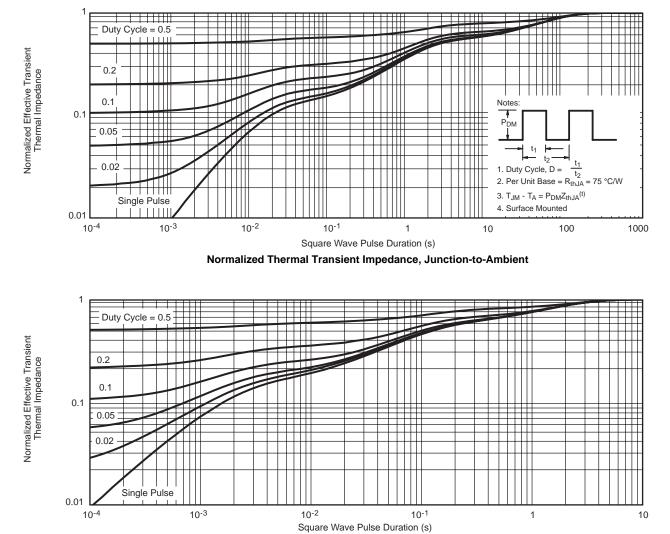






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





| | MILLIM | MILLIMETERS | | HES | | |
|---|--------|-------------|--------|-------|--|--|
| DIM | Min | Max | Min | Max | | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 | 0 BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | | |



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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